

MAX14975

Robust Dual USB 3.0 Equalizer/Redriver with Extended Temperature Operation

General Description

The MAX14975 dual SuperSpeed USB 3.0 equalizer/redriver utilizes programmable input equalization and output deemphasis to reduce deterministic jitter and restore signal loss caused by circuit-board or signal-cable losses, and allows optimal placement of key SuperSpeed USB 3.0 components and longer circuit-board traces or cables. The device features advanced power management with receiver detection and explicit support for USB 3.0 low-frequency periodic signals (LFPS).

The device is available in a small, 24-pin (4.0mm x 4.0mm) TQFN package with flow-through traces for optimal layout and minimal space requirements. The device is specified over the -40°C to +85°C extended operating temperature range.

Applications

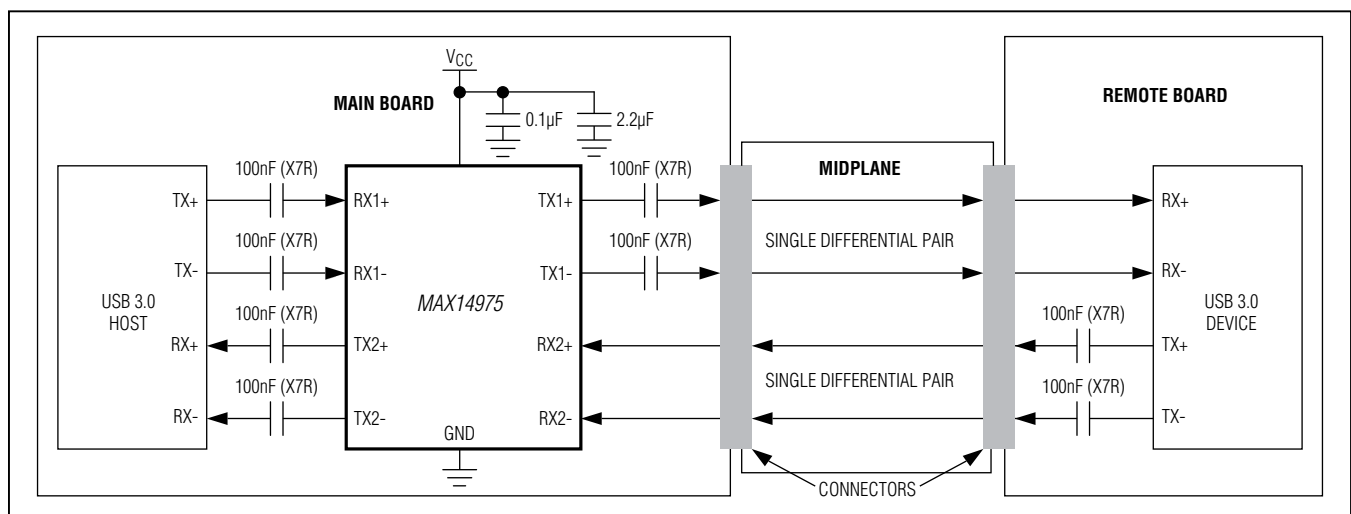
Industrial/Embedded PC
 Computer on Modules
 Carrier Boards
 Test Equipment
 Rack Server Industrial PCs
 Medical Equipment

Benefits and Features

- ◆ **Advanced Power-Saving Sleep Modes**
 - ◇ Standby State: < 1mW (typ)
 - ◇ Receiver Detect State: 23mW (typ)
 - ◇ Dynamic Power-Down State: 82.5mW (typ)
 - ◇ Active State: 304mW (typ)
- ◆ **High-Performance Solution Designed to Overcome Lossy Channels**
 - ◇ Three Levels of Input Equalization Up to 10dB
 - ◇ Six Levels of Output Deemphasis Up to 4dB
 - ◇ Compensates Up to 30in of Channel Losses with Deterministic Jitter: 12ps_{p-p} (max); Random Jitter: 1ps_{RMS} (max)
 - ◇ 10dB (typ) of Return Loss Up to 2.5GHz
- ◆ **Designed to Reliably Operate in Harsh Environments**
 - ◇ Industrial Temperature Rated: -40°C to + 85°C
 - ◇ ±8kV Human Body Model (HBM) ESD Protection on All Pins
 - ◇ Housed in a Flow-Through (4.0mm x 4.0mm, 24-Pin) TQFN Package for Resistance to Vibration/Shocks

[Ordering Information](#) appears at end of data sheet.

Typical Operating Circuit



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND.)

V _{CC}	-0.3V to +4.0V
All Other Pins (Note 1)	-0.3V to (V _{CC} + 0.3V)
Continuous Current RX ₊ , RX ₋ , TX ₊ , TX ₋	±30mA
Continuous Power Dissipation (T _A = +70°C) TQFN (derate 27.8mW/°C above +70°C)	2222.2mW

Operating Temperature Range	-40°C to +85°C
Junction Temperature Range	-40°C to +150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Note 1: All I/O pins are clamped by internal diodes.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 2)

TQFN

Junction-to-Ambient Thermal Resistance (θ _{JA})	36°C/W
Junction-to-Case Thermal Resistance (θ _{JC})	3°C/W

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +3.0V to +3.6V, C_C = 100nF coupling capacitor on each output, R_L = 50Ω and C_L = 1pF on each output, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.3V and T_A = +25°C.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DC PERFORMANCE						
Power-Supply Range	V _{CC}		3.0	3.3	3.6	V
Operating Supply Current	I _{CC}	ENRXD = 1, data rate = 5.0Gbps, D10.2 pattern, DE ₋ = V _{CC} , OS ₋ = GND		92	125	mA
		ENRXD = 1, CM = 0, no output termination		7	10	
		Dynamic power-down mode, ENRXD = 1, CM = 0, with output termination, no input signal		25	32	
Standby Supply Current	I _{STBY}	ENRXD = 0			600	μA
Differential Input Impedance	Z _{RX-DC-DIFF}	DC	72		120	Ω
Differential Output Impedance	Z _{TX-DC-DIFF}	DC	72		120	Ω
Single-Ended High Input Impedance	Z _{RX-SE-HIGH}	No output termination, CM = 0 (Note 4)	25	50		kΩ
Common-Mode Input Impedance	Z _{RX-DC-CM}	(Note 4)	18		30	Ω
Common-Mode Output Impedance	Z _{TX-DC-CM}	(Note 5)	18		30	Ω
Common-Mode Input Voltage	V _{RX-DC-CM}	(Note 4)		0		V
Common-Mode Output Voltage	V _{TX-DC-CM}	(Note 4)		2.75		V
Active LFPS Common-Mode Delta	ΔV _{LFPS-CM}	Active LFPS squelched and not squelched			50	mV

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ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +3.0V$ to $+3.6V$, $C_C = 100nF$ coupling capacitor on each output, $R_L = 50\Omega$ and $C_L = 1pF$ on each output, $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted. Typical values are at $V_{CC} = +3.3V$ and $T_A = +25^\circ C$.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
AC PERFORMANCE (Note 6)						
Redriver-Operation Differential Input Signal Range	$V_{RX-DIFF-PP}$	USB 3.0 data	150		1200	mV _{P-P}
LFPS Detect Threshold	$V_{LFPS-DIFF-PP}$	USB 3.0 LFPS pattern	100		300	mV
Differential Input Return Loss	$RL_{RX-DIFF}$	$50MHz \leq f < 1250MHz$	13	18		dB
		$1250MHz \leq f < 2500MHz$	8	12		
Differential Output Return Loss	$RL_{TX-DIFF}$	$50MHz \leq f < 1250MHz$	13	16		dB
		$1250MHz \leq f < 2500MHz$	8	10		
Common-Mode Input Return Loss	RL_{RX-CM}	$50MHz \leq f < 2500MHz$	11	13		dB
Common-Mode Output Return Loss	RL_{TX-CM}	$50MHz \leq f < 2500MHz$	10	13		dB
Differential Output Amplitude (Transition Bit), Figure 1	$V_{TX-DIFF-TB-PP}$	$OS_ = 0, DE_ = 0$		1120		mV _{P-P}
		$OS_ = 0, DE_ = N.C.$		940		
		$OS_ = 0, DE_ = 1$		1210		
		$OS_ = 1$ or N.C., $DE_ = 0$		1180		
		$OS_ = 1$ or N.C., $DE_ = N.C.$		1010		
		$OS_ = 1$ or N.C., $DE_ = 1$		1270		
Differential Output Amplitude (Nontransition Bit), Figure 1	$V_{TX-DIFF-NTB-PP}$	$DE_ = N.C.$		640		mV _{P-P}
		$DE_ = 0$		840		
		$DE_ = 1$		940		
LFPS Idle Differential Output Voltage	$V_{LFPS-IDLE-DIFF-PP}$	Highpass filter to remove DC offset			30	mV
Voltage Change to Allow Receiver Detect	V_{DETECT}	Positive voltage to sense receiver termination		500		mV
Deterministic Jitter	$t_{TX-DJ-DD}$	K28.5 pattern, data rate = 5.0Gbps, $EQ_ =$ not connected			12	ps _{P-P}
Random Jitter	$t_{TX-RJ-DD}$	D10.2 pattern, data rate = 5.0Gbps, $EQ_ =$ not connected			1	ps _{RMS}
Rise/Fall Time	$t_{TX-RISE-FALL}$	(Note 7)	40			ps
Differential Propagation Delay	t_{PD}	Propagation delay input to output at 50%		250		ps
LFPS Idle Entry Delay	$t_{IDLE-ENTRY}$	USB 3.0 LFPS pattern, active state		4	7	ns
LFPS Idle Exit Delay	$t_{IDLE-EXIT}$	USB 3.0 LFPS pattern, active state		4	6	ns
		USB 3.0 LFPS pattern, dynamic power-down state		15.6	22.5	

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ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +3.0V$ to $+3.6V$, $C_C = 100nF$ coupling capacitor on each output, $R_L = 50\Omega$ and $C_L = 1pF$ on each output, $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted. Typical values are at $V_{CC} = +3.3V$ and $T_A = +25^\circ C$.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CONTROL LOGIC						
Input Logic-High	V_{IH}	ENRXD, CM, EQ_, OS_, and DE_	1.5			V
Input Logic-Low	V_{IL}	ENRXD, CM, EQ_, OS_, and DE_			0.5	V
Input Logic Hysteresis	V_{HYST}	ENRXD, CM, EQ_, OS_, and DE_		0.075		V
ESD PROTECTION						
HBM ESD Protection		Human Body Model		± 8		kV

Note 3: All parts are production tested at $T_A = +25^\circ C$, $+85^\circ C$.

Note 4: Measured with respect to ground.

Note 5: Measured with respect to V_{CC} .

Note 6: Guaranteed by design, unless otherwise noted.

Note 7: Rise and fall times are measured using 20% and 80% levels.

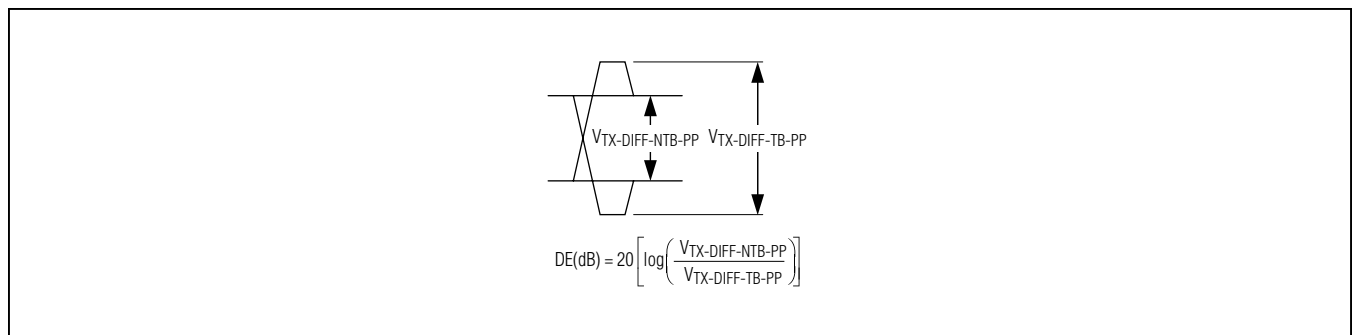


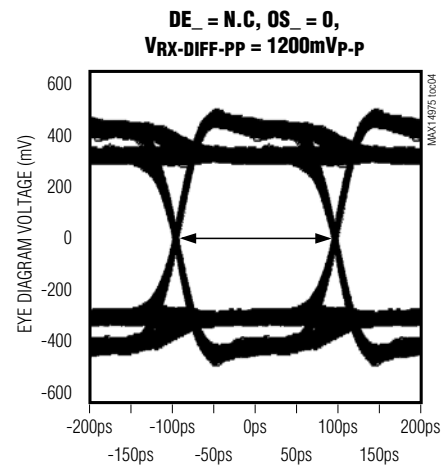
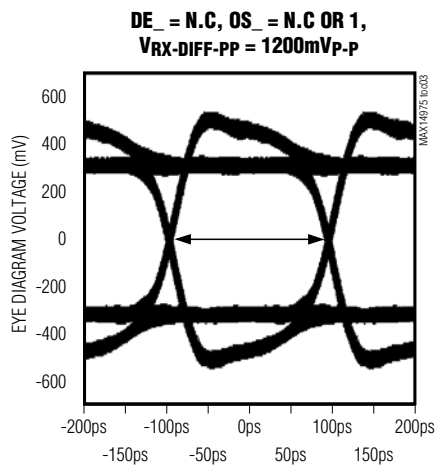
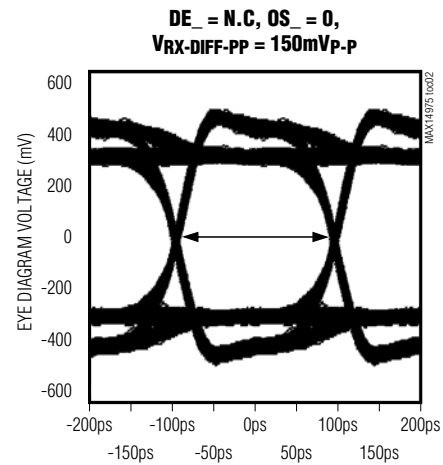
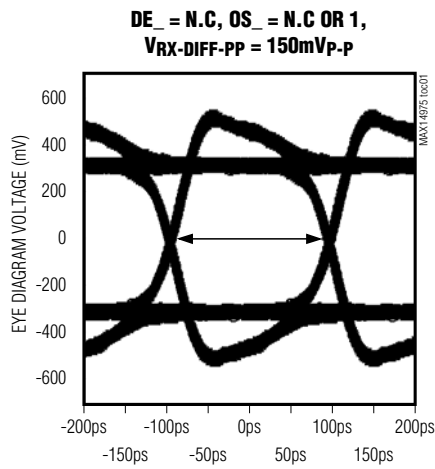
Figure 1. Illustration of Output Deemphasis

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Typical Operating Characteristics

($V_{CC} = 3.3V$, $T_A = +25^\circ C$, $EQ_- = N.C.$, using 5Gbps $\pm K28.5$ pattern, unless otherwise noted.)

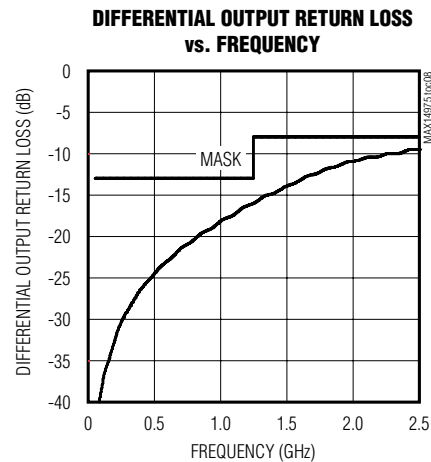
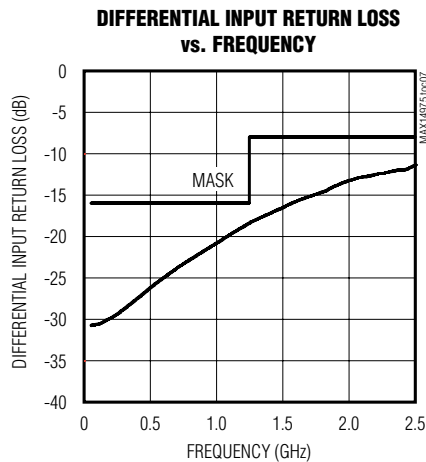
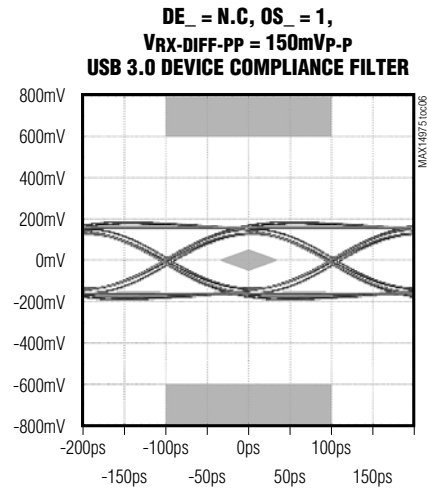
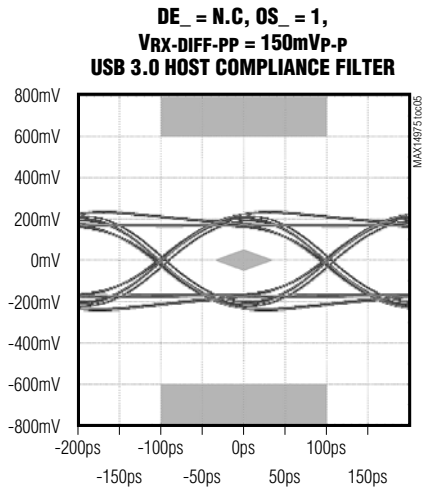


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Typical Operating Characteristics (continued)

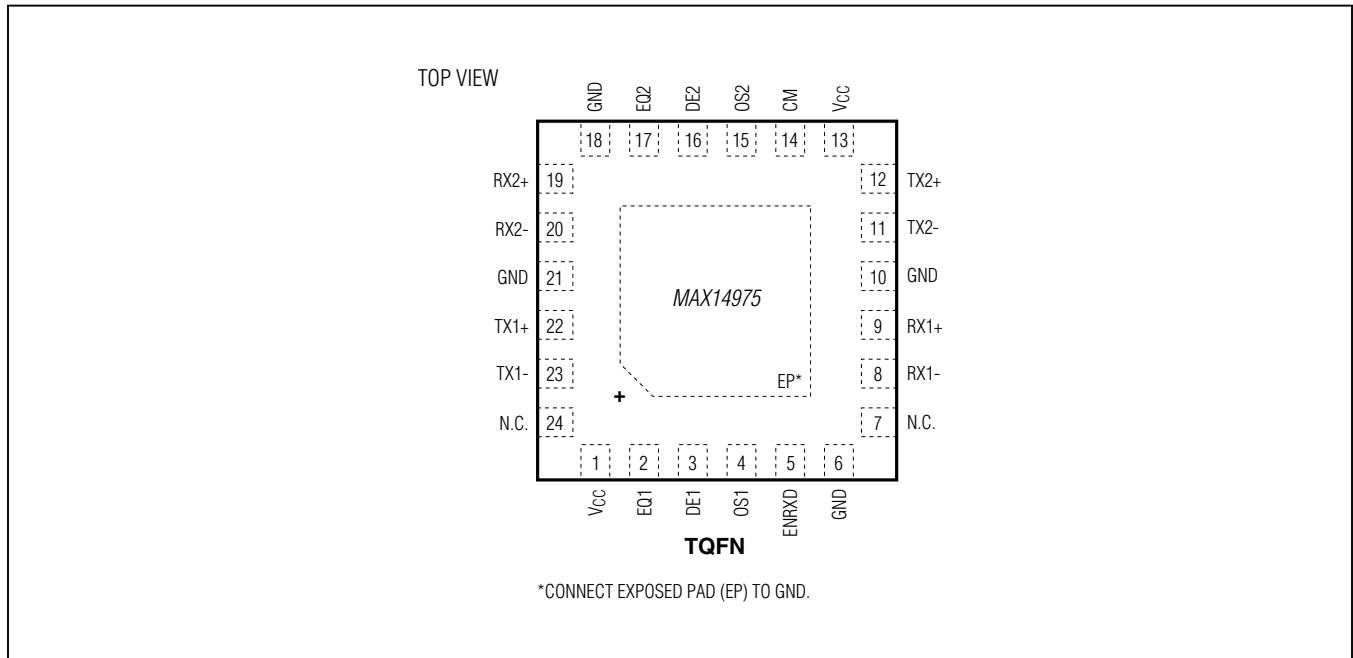
($V_{CC} = 3.3V$, $T_A = +25^\circ C$, $EQ_- = N.C.$, using 5Gbps $\pm K28.5$ pattern, unless otherwise noted.)



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Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1, 13	V _{CC}	Power-Supply Input. Bypass V _{CC} to GND with 0.1μF and 2.2μF low-ESR capacitors in parallel as close as possible to the device.
2	EQ1	Three-State Input Equalization Control, Channel 1. Leave EQ1 unconnected for default state.
3	DE1	Three-State Transition Bit and Nontransition Bit Output Amplitude Control, Channel 1. Connect DE1 to V _{CC} for default state.
4	OS1	Two-State Transition-Bit Output Amplitude Control, Channel 1. Connect OS1 to GND for default state.
5	ENRXD	Active-High Enable. Drive ENRXD high or leave unconnected for normal operation. Drive ENRXD low to enter standby state. ENRXD has a 400kΩ (typ) pullup resistor to V _{CC} .
6, 10, 18, 21	GND	Ground
7, 24	N.C.	No Connection. Not internally connected.
8	RX1-	Inverting Input, Channel 1. AC-couple RX1- with a low-ESR 100nF capacitor.
9	RX1+	Noninverting Input, Channel 1. AC-couple RX1+ with a low-ESR 100nF capacitor.
11	TX2-	Inverting Output, Channel 2. AC-couple TX2- with a low-ESR 100nF capacitor.
12	TX2+	Noninverting Output, Channel 2. AC-couple TX2+ with a low-ESR 100nF capacitor.
14	CM	Active-High Compliance Mode Control. Drive CM high to force active state. Drive CM low or leave unconnected for normal operation. CM has a 400kΩ (typ) pulldown resistor to GND.

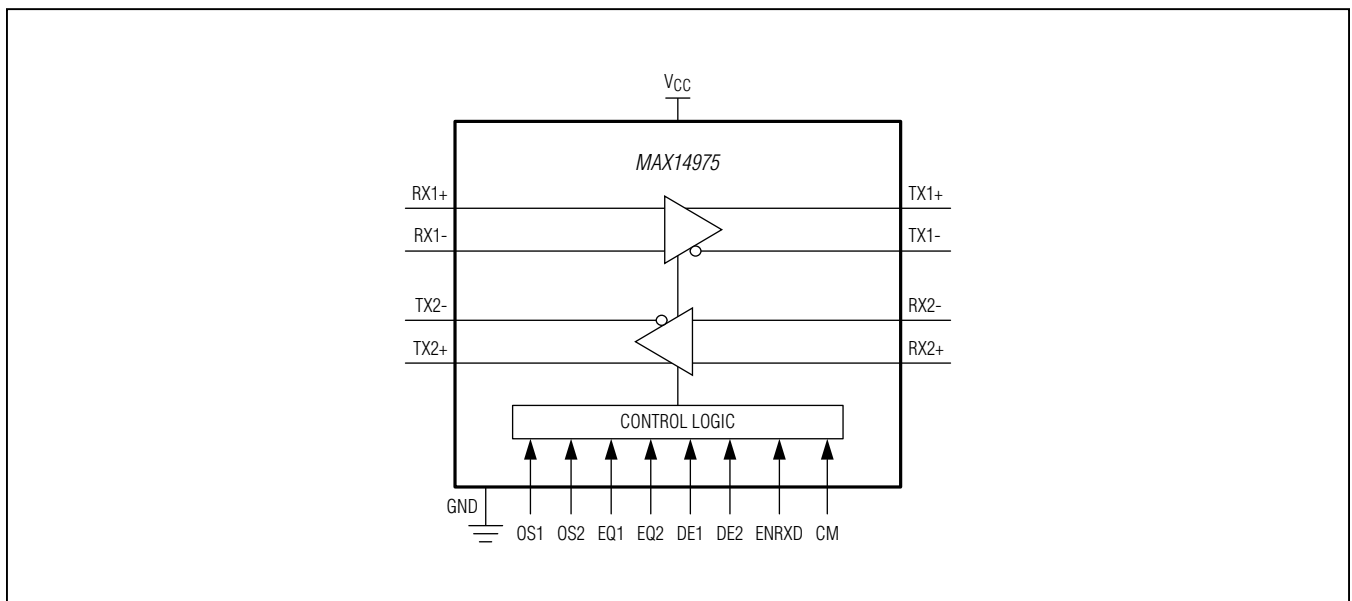
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Pin Description (continued)

PIN	NAME	FUNCTION
15	OS2	Two-State Transition-Bit Output Amplitude Control, Channel 2. Connect OS2 to GND for default state.
16	DE2	Three-State Transition Bit and Nontransition Bit Output Amplitude Control, Channel 2. Connect DE2 to V _{CC} for default state.
17	EQ2	Three-State Input Equalization Control, Channel 2. Leave EQ2 unconnected for default state.
19	RX2+	Noninverting Input, Channel 2. AC-couple RX2+ with a low-ESR 100nF capacitor.
20	RX2-	Inverting Input, Channel 2. AC-couple RX2- with a low-ESR 100nF capacitor.
22	TX1+	Noninverting Output, Channel 1. AC-couple TX1+ with a low-ESR 100nF capacitor.
23	TX1-	Inverting Output, Channel 1. AC-couple TX1- with a low-ESR 100nF capacitor.
—	EP	Exposed Pad. Internally connected to GND. Connect to a large ground plane to maximize thermal performance. Not intended as an electrical connection point.

Functional Diagram



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Detailed Description

The MAX14975 features two identical drivers to support a complete single SuperSpeed USB 3.0 link. Programmable equalization and deemphasis on each channel allows for optimal board placement of SuperSpeed transceivers and enables flexibility of front, rear, and side SuperSpeed ports. The device features advanced power management with receiver detection and support for USB 3.0 low-frequency periodic signals (LFPS).

Programmable Input Equalization

Input equalization for channel 1 is controlled by EQ1, while input equalization for channel 2 is controlled by EQ2. Each of the two pins, EQ1 and EQ2, has three equalization settings that offer flexible compensation for varied input circuit-board trace, connector, or cable losses (Table 1). The EQ_ three-state inputs interpret voltages below V_{IH} and higher than V_{IL} as high impedance. Set EQ_ to 1V, for example, or leave unconnected if the impedance state is required.

Programmable Output Deemphasis

Channel 1 output transition bit amplitude is controlled by the OS1 and DE1 pins, and the nontransition bit amplitude is controlled only by the DE1 pin. Channel 2 output transition bit amplitude is controlled by the OS2 and DE2 pins, and the nontransition bit amplitude is

controlled only by the DE2 pin. There are six possible output deemphasis states for each of the two channels that offer flexibility to compensate for varied losses in the output circuit-board traces, connectors, or cable runs (Table 2, Table 3, and Table 4.) The DE_ three-state input interprets voltages below V_{IH} and higher than V_{IL} as high impedance. Set DE_ to 1V, for example, or leave unconnected if a high-impedance state is required.

LFPS Support

The device explicitly supports USB 3.0 LFPS by detecting an idle state at the input and squelching the corresponding output to prevent unwanted noise from being redriven. When the differential input LFPS signal falls below the 100mV_{p-p} threshold, the device squelches the output. When a differential LFPS signal above 300mV_{p-p} (typ) is present at the input, the device turns on the corresponding output and redrives the signal. The device features an LFPS idle entry time of 4ns (typ) and exit time of 4ns (typ) in the active state.

Advanced Power Management

Standby State

Drive ENRXD low to place the device into a low-power standby state. In standby, the inputs are in a common-mode high-impedance state and the device consumes less than 1mW (typ) of power. The entry time to standby is 2μs (typ), and the exit time is 50μs (typ).

Table 1. Typical Input Equalization

EQ_	EQUALIZATION (dB)
N.C.*	0
0	6
1	10

*Not connected.

Table 2. Typical Output Transition Bit Amplitude (See the *Electrical Characteristics* Table)

OS_	AMPLITUDE (mV _{p-p})
N.C.*, 1	1010 to 1270
0	940 to 1210

*Not connected.

Table 3. Typical Output Nontransition Bit Amplitude

DE_	AMPLITUDE (mV _{p-p})
N.C.*	640
0	840
1	940

*Not connected.

Table 4. Typical Output Deemphasis

CONTROL LOGIC	OS_ = 0 (dB)	OS_ = 1, N.C.* (dB)
DE_ = 0	-2.5	-3.0
DE_ = N.C.	-3.3	-3.9
DE_ = 1	-2.2	-2.7

*Not connected.

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Receiver Detection

The device features independent receiver detection on each channel. Upon initial power-up, if ENRXD is high, receiver detection initializes. If the device is in a powered-up state, the receiver detection is initiated on the rising edge of ENRXD. During receiver detection, the part remains in low-power mode 23mW (typ) and the outputs and inputs are in a common-mode high-impedance state. The receiver detection repeats every 12ms (typ) until the receiver is detected. The receiver must be detected on both channels to exit the receiver detection state.

Dynamic Power-Down

The device enters dynamic power-down state when a receiver has been detected and no signal is present at the input. The device exits this state when a signal is detected at the input. The device consumes less than 82.5mW (typ) power in dynamic power-down state. The device enters dynamic power-down after 30μs idle detection. If no signal is detected for more than 12ms (typ), the part enters receiver detection state.

Active State

The device automatically enters active state after a receiver is detected and an input signal is present. The part can be forced into the active state by setting CM = 1 as shown in Table 5. The device consumes less than 304mW (typ) of power in this state.

USB 3.0 Compliance Mode

The MAX14975 features a USB 3.0 compliance mode that forces the device to remain in the active state. The device redrives signals to test the transmitter for voltage and timing specifications compliance as required by USB 3.0 specifications. Drive ENRXD high or leave

unconnected, and CM high to activate USB 3.0 compliance mode. Drive ENRXD high or leave unconnected, and CM low or leave unconnected for normal operation (Table 5). Receiver detection and dynamic power-down are disabled in compliance mode (CM = 1), while the part remains in the active state with functional LFPS support.

Applications Information

Layout

Circuit-board layout and design can significantly affect the performance of the device. Use good high-frequency design techniques, including minimizing ground inductance and using controlled-impedance transmission lines on data signals. Power-supply decoupling capacitors must be placed as close as possible to V_{CC}. Always connect V_{CC} to a power plane.

Exposed-Pad Package

The exposed pad, 24-pin TQFN package incorporates features that provide a very low thermal resistance path for heat removal from the IC. The exposed pad on the device must be soldered to the PCB ground plane for proper electrical and thermal performance. For more information on exposed-pad packages, refer to Application Note 862: HFAN-08.1: Thermal Considerations of QFN and Other Exposed-Paddle Packages.

Power-Supply Sequencing

Caution: Do not exceed the absolute maximum ratings because stresses beyond the listed ratings can cause permanent damage to the device.

Proper power-supply sequencing is recommended for all devices. Always apply GND then V_{CC} before applying signals, especially if the signal is not current limited.

Table 5. Digital Control Truth Table

ENRXD	CM	DESCRIPTION
0	0	Power-down
0	1	Power-down
1 or N.C.*	0 or N.C.*	Normal operation
1 or N.C.*	1	Compliance mode (active)

*Not connected.

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX14975ETG+	-40°C to +85°C	24 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

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Chip Information

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
24 TQFN-EP	T2444+3	21-0139	90-0021

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	11/12	Initial release	—



Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.

Maxim Integrated 160 Rio Robles, San Jose, CA 95134 USA 1-408-601-1000

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